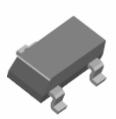
P-Channel 20-V (D-S) MOSFET

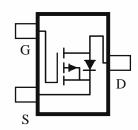
These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

V _{DS} (V)	r _{DS(on)} (OHM)	I _D (A)
-20	$0.130 @ V_{GS} = -4.5V$	-2.6
-20	$0.190 @ V_{GS} = -2.5V$	-2.1

DD ODLIGT CLIMAN ADAZ

- Low r_{DS(on)} provides higher efficiency and extends battery life
- Low thermal impedance copper leadframe SOT-23 saves board space
- · Fast switching speed
- High performance trench technology





ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C UNLESS OTHERWISE NOTED)					
Parameter			Maximum	Units	
Drain-Source Voltage		V_{DS}	-20	V	
Gate-Source Voltage			±8	V	
Continuous Drain Current ^a	$T_A=25^{\circ}C$ $T_A=70^{\circ}C$	I _D	-2.6		
Continuous Drain Current	$T_A=70^{\circ}C$	ъ	-1.5	A	
Pulsed Drain Current ^b		I_{DM}	-10		
Continuous Source Current (Diode Conduction) ^a		I_S	±1.6	A	
D. a. a. a. a. a.	T _A =25°C	D _D	1.25	W	
Power Dissipation ^a	$T_A=25^{\circ}C$ $T_A=70^{\circ}C$	1 D	0.8	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Maximum	Units			
Maximum lunation to Ambient ^a	t <= 5 sec	D	100	°C/W			
Maximum Junction-to-Ambient ^a	Steady-State	$R_{\scriptscriptstyle \mathrm{THJA}}$	166	C/VV			

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

(C)

	G 1 1	T. (C. 11)	Limits			T T •4	
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static							
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250 \text{ uA}$	-0.4		-1		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = +/-8 \text{ V}$			±100	nA	
Zara Cata Valtaga Drain Current	In as	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$			-1	uA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			-10	uA	
On-State Drain Current ^A	I	V = -5 V, V = -4.5 V	-3			Α	
D i G O D i A	fDS(on) D(on)	$V_{GS} = -4.5 \text{ V}, I_D = -2.6 \text{ A}$			0.130	Ω	
Drain-Source On-Resistance ^A		$V_{\Phi S} = -2.5 \text{ V}, I_{\Phi S} = -2.1 \text{ A}$			0.190		
Forward Tranconductance ^A	g	V = -5 V, I = -2.8 A		3		S	
Diode Forward Voltage	V_{SD}	$I_S = -1.6 \text{ A}, V_{GS} = 0 \text{ V}$		-0.70		V	
Dynamic ^b	fs	DS D					
Total Gate Charge	Qg	V- 5 V V- 45 V		12.2		nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V},$ $I_{D} = -2.6 \text{ A}$		1.1			
Gate-Drain Charge	Qgd	ID = -2.0 A		1.5			
Turn-On Delay Time	t _{d(on)}			6.5			
Rise Time	t _r	$V_{\mathrm{DD}} = -5 \text{ V}, R_{\mathrm{L}} = 5 \text{ OHM},$		20		ns	
Turn-Off Delay Time	t _{d(off)}	$V_{GEN} = -4.5 \text{ V}, R_G = 6 \text{ OHM}$		31			
Fall-Time	tf	1		21			

Notes

- a. Pulse test: $PW \le 300us duty cycle \le 2\%$.
- b. Guaranteed by design, not subject to production testing.

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Typical Electrical Characteristics

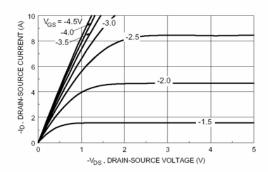


Figure 1. On-Region Characteristics.

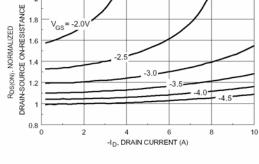


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

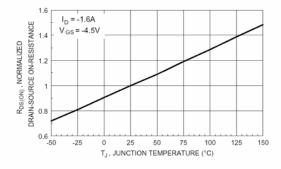


Figure 3. On-Resistance Variation with Temperature.

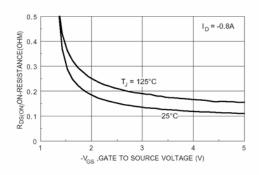


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

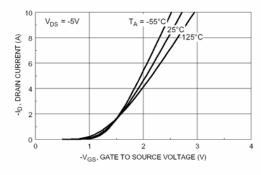


Figure 5. Transfer Characteristics.

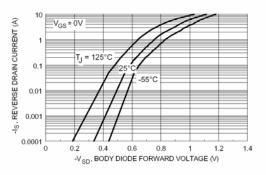


Figure 6 . Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Electrical Characteristics

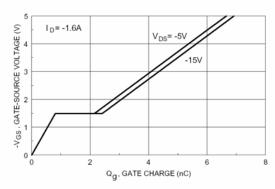


Figure 7. Gate Charge Characteristics.

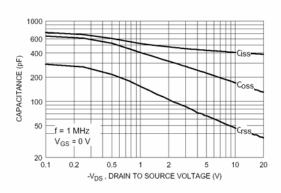


Figure 8. Capacitance Characteristics.

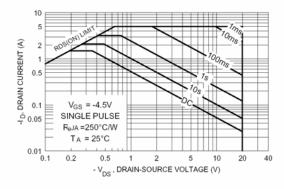


Figure 9. Maximum Safe Operating Area.

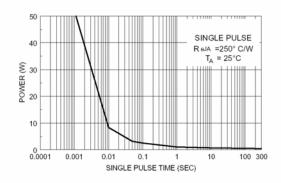


Figure 10. Single Pulse Maximum Power Dissipation.

Normalized Thermal Transient Junction to Ambient

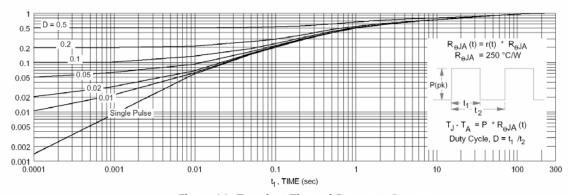
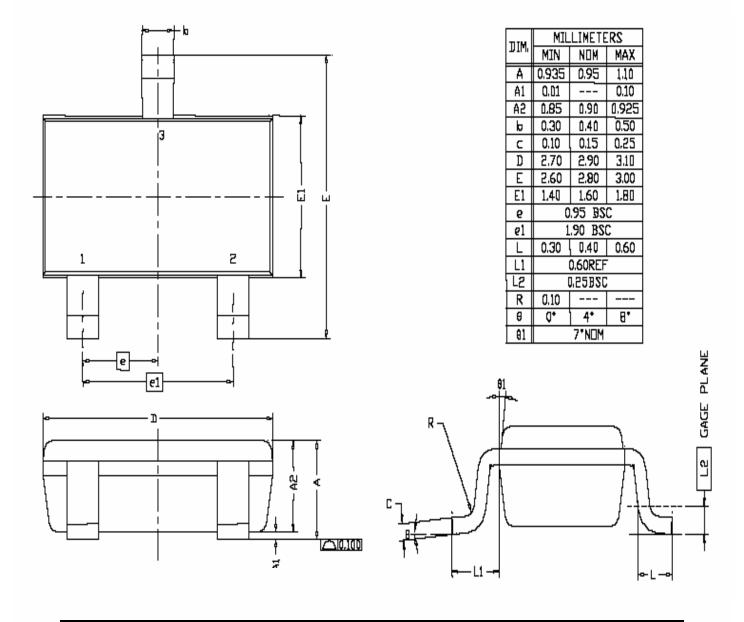


Figure 11. Transient Thermal Response Curve.

Package Information



Ordering information

• AM2301P-T1-XX

A: Analog Power

- M: MOSFET

- 2301: Part number

- P: P-Channel

- T1: Tape & reel

- XX: Blank: Standard

PF: Leadfree